

UTT50N06

Power MOSFET

50A, 60V N-CHANNEL
POWER MOSFET

■ DESCRIPTION

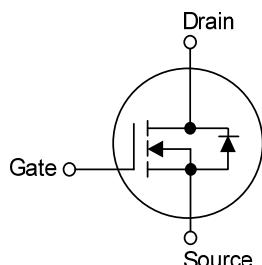
The UTC **UTT50N06** is an N-channel power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance and superior switching performance.

The UTC **UTT50N06** is generally applied in low power switching mode power appliances and electronic ballast.

■ FEATURES

- * $R_{DS(ON)} \leq 20m\Omega$ @ $V_{GS}=10V$, $I_D=25A$
- * High Switching Speed
- * Improved dv/dt capability

■ SYMBOL



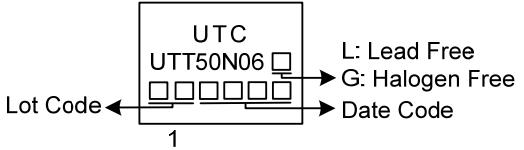
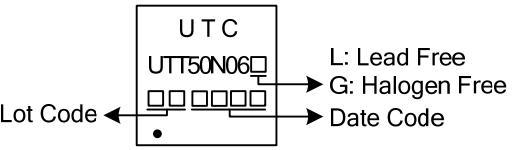
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UTT50N06L-TA3-T	UTT50N06G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
UTT50N06L-TF3-T	UTT50N06G-TF3-T	TO-220F	G	D	S	-	-	-	-	-	Tube
UTT50N06L-TF1-T	UTT50N06G-TF1-T	TO-220F1	G	D	S	-	-	-	-	-	Tube
UTT50N06L-TM3-T	UTT50N06G-TM3-T	TO-251	G	D	S	-	-	-	-	-	Tube
UTT50N06L-TN3-R	UTT50N06G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UTT50N06L-TND-R	UTT50N06G-TND-R	TO-252D	G	D	S	-	-	-	-	-	Tape Reel
UTT50N06L-TQ2-T	UTT50N06G-TQ2-T	TO-263	G	D	S	-	-	-	-	-	Tube
UTT50N06L-TQ2-R	UTT50N06G-TQ2-R	TO-263	G	D	S	-	-	-	-	-	Tape Reel
UTT50N06L-K08-5060-R	UTT50N06G-K08-5060-R	DFN5060-8	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 (1) Packing Type (2) Package Type (3) Green Package	(1) T: Tube, R: Tape Reel
	(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TM3: TO-251, TN3: TO-252, TND: TO-252D,
	TQ2: TO-263, K08-5060: DFN5060-8
(3) G: Halogen Free and Lead Free, L: Lead Free	

■ MARKING

TO-220 / TO-220F / TO-220F1 / TO-251 TO-252 / TO-252D / TO-263	DFN5060-8
 <p>Lot Code ← 1 → Date Code L: Lead Free G: Halogen Free</p>	 <p>Lot Code ← ● → Date Code L: Lead Free G: Halogen Free</p>

■ ABSOLUTE MAXIMUM RATINGS (($T_c=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	60	V
Gate-Source Voltage		V_{GSS}	± 20	V
Continuous Drain Current		I_D	50	A
Pulsed Drain Current (Note 2)		I_{DM}	150	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	92	mJ
Peak Diode Recovery dv/dt		dv/dt	10	V/ns
Power Dissipation	TO-220/TO-263	P_D	100	W
	TO-220F/TO-220F1		36	W
	TO-251/TO-252		46	W
	TO-252D		20.8	W
	DFN5060-8			
Junction Temperature		T_J	+150	$^\circ\text{C}$
Operation and Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. L=43mH, $I_{AS}=43\text{A}$, $V_{DD}=25\text{V}$, $R_G=20\Omega$, Starting $T_J=25^\circ\text{C}$

4. $I_{SD} \leq 30\text{A}$, $V_{DS}=0\text{V}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-263	θ_{JA}	62	$^\circ\text{C/W}$
	TO-251/TO-252 TO-252D		100	$^\circ\text{C/W}$
	DFN5060-8		65	$^\circ\text{C/W}$
Junction to Case	TO-220/TO-263	θ_{JC}	1.24	$^\circ\text{C/W}$
	TO-220F/TO-220F1		3.47	$^\circ\text{C/W}$
	TO-251/TO-252 TO-252D		2.7 (Note)	$^\circ\text{C/W}$
	DFN5060-8		6 (Note)	$^\circ\text{C/W}$

Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

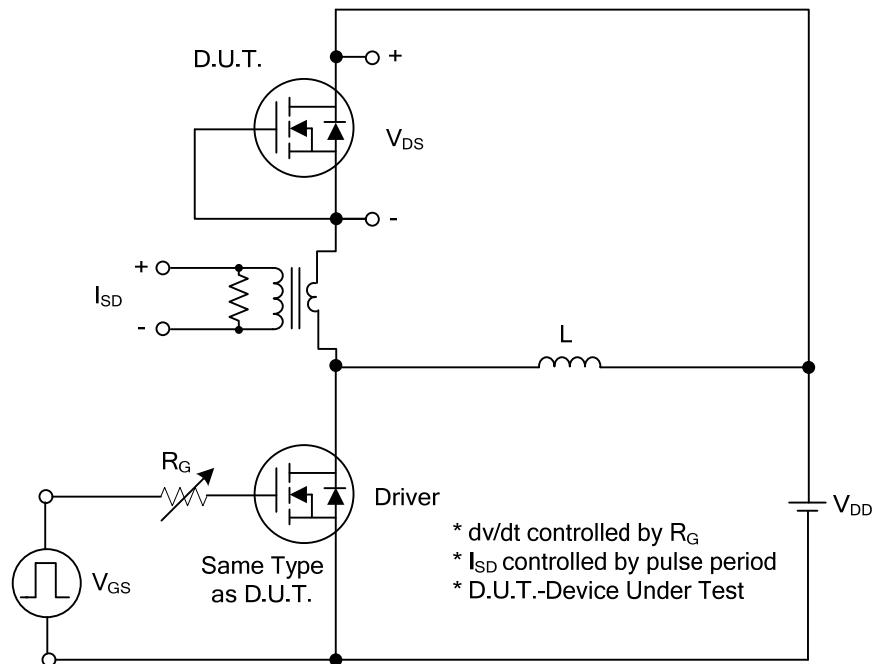
■ ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	60			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$		10		μA
Gate-Source Leakage Current	Forward	$V_{\text{GS}}=20\text{V}, V_{\text{DS}}=0\text{V}$		100	nA	
	Reverse	$V_{\text{GS}}=-20\text{V}, V_{\text{DS}}=0\text{V}$		-100	nA	
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.0		3.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=25\text{A}$		20		$\text{m}\Omega$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=25\text{V}, f=1\text{MHz}$		2500		pF
Output Capacitance	C_{OSS}			230		pF
Reverse Transfer Capacitance	C_{RSS}			200		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge	Q_G	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=1.3\text{A}$ $I_G=3\text{mA}$ (Note1,2)		7.2		nC
Gate-Source Charge	Q_{GS}			0.4		nC
Gate-Drain Charge	Q_{GD}			0.8		nC
Turn-On Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=50\text{A},$ $R_G=25\Omega$ (Note1,2)		18		ns
Turn-On Rise Time	t_R			46		ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			202		ns
Turn-Off Fall Time	t_F			116		ns
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Maximum Continuous Drain-Source Diode Forward Current	I_S	$I_S=50\text{A}, V_{\text{GS}}=0\text{V}$			50	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				150	A
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=50\text{A}, V_{\text{GS}}=0\text{V}$			1.5	V
Body Diode Reverse Recovery Time	t_{rr}	$I_S=30\text{A}, V_{\text{GS}}=0\text{V},$ $dI_S/dt=100\text{A}/\mu\text{s}$		50		ns
Body Diode Reverse Recovery Charge	Q_{rr}			80		nC

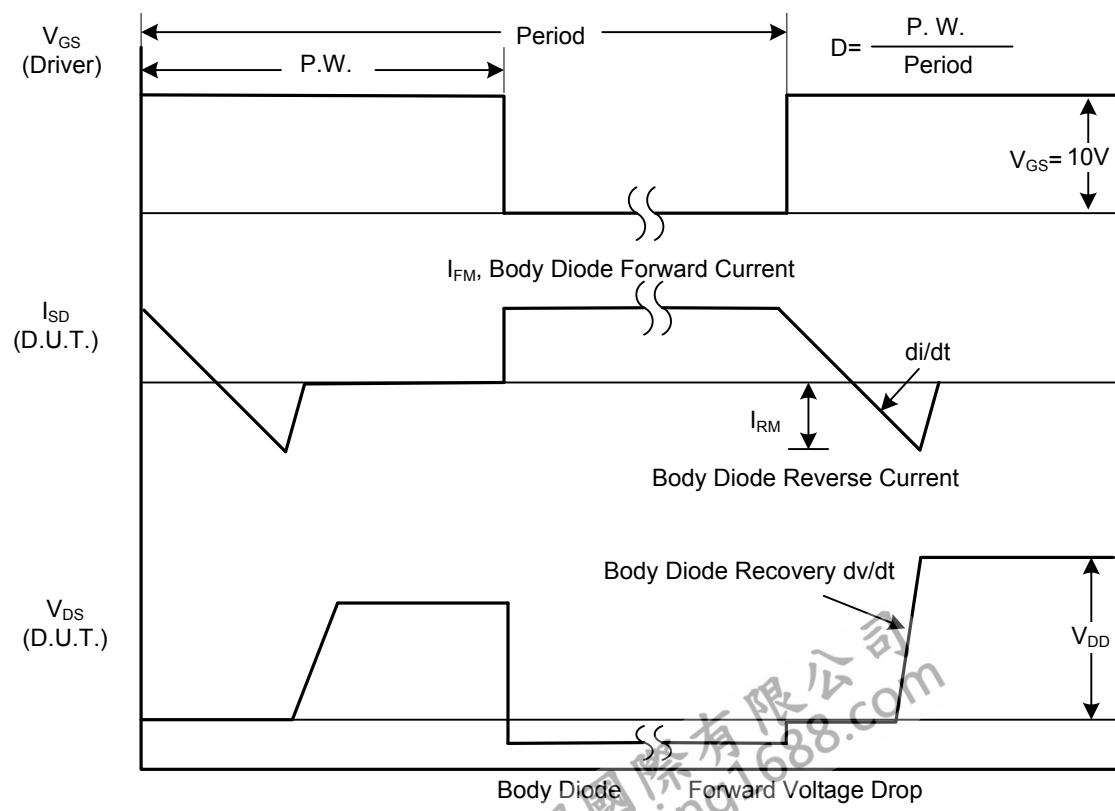
Notes: 1. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS

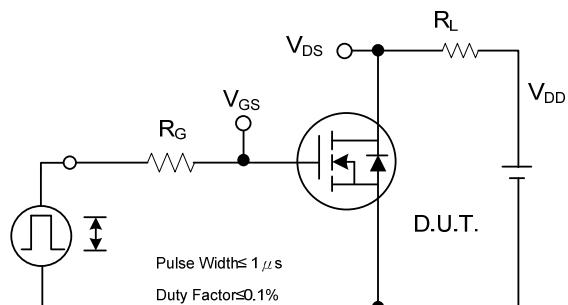


Fig. 2A Switching Test Circuit

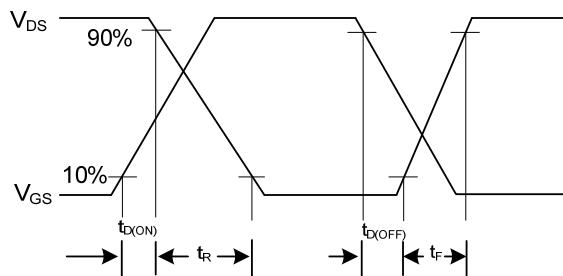


Fig. 2B Switching Waveforms

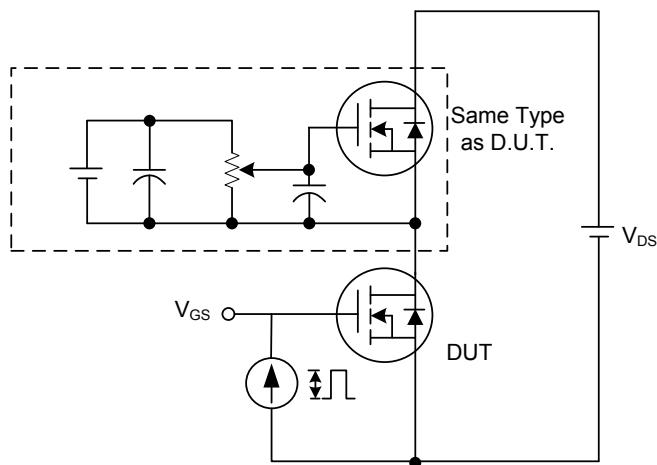


Fig. 3A Gate Charge Test Circuit

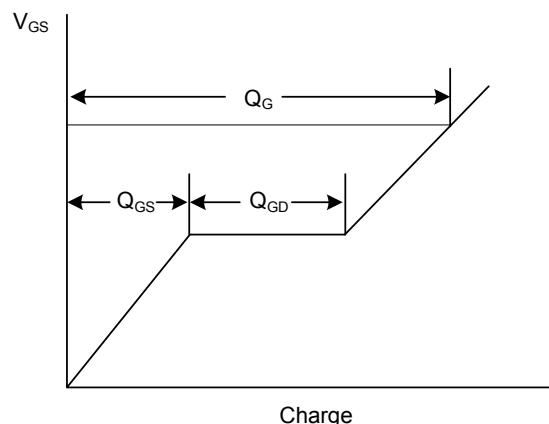


Fig. 3B Gate Charge Waveform

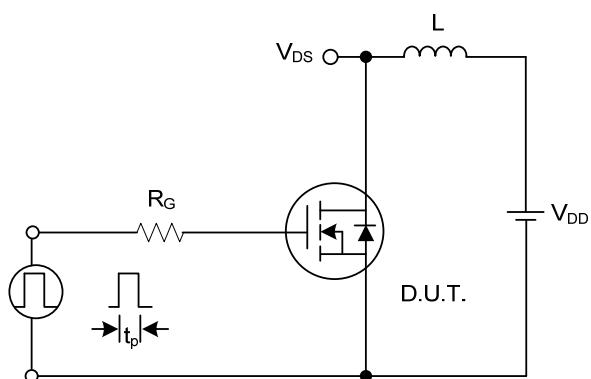


Fig. 4A Unclamped Inductive Switching Test Circuit

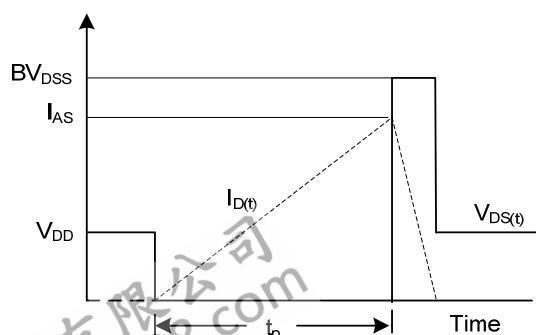
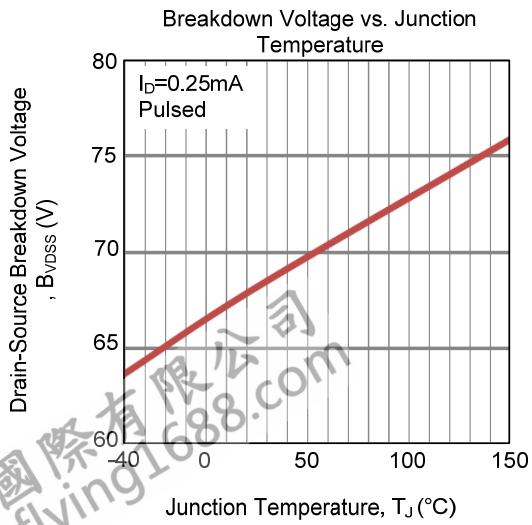
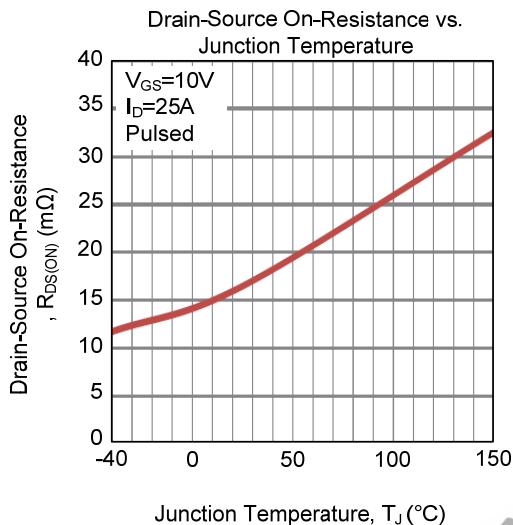
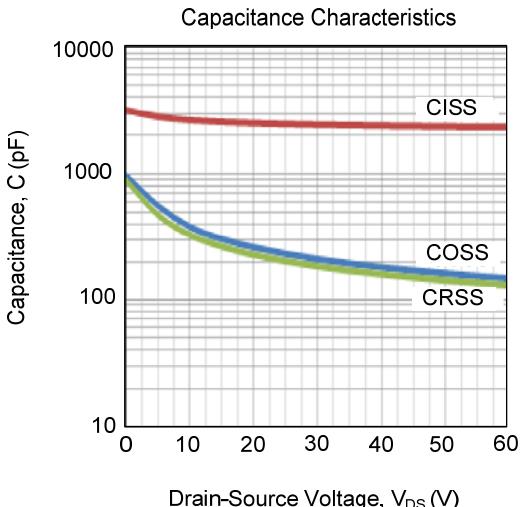
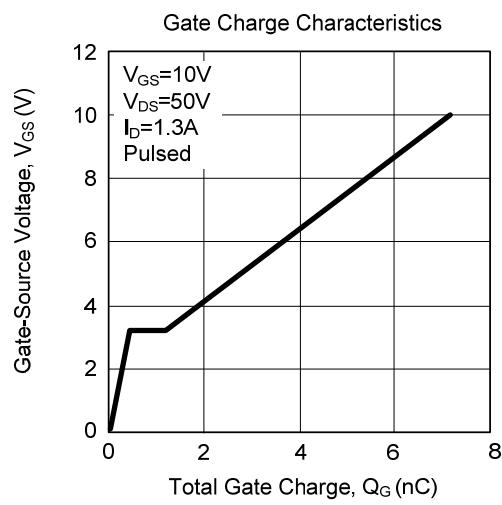
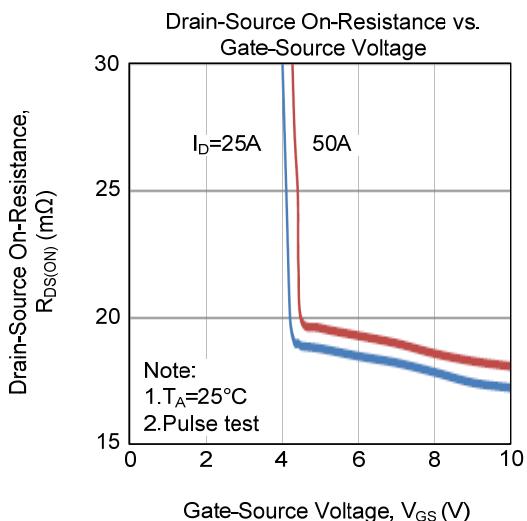
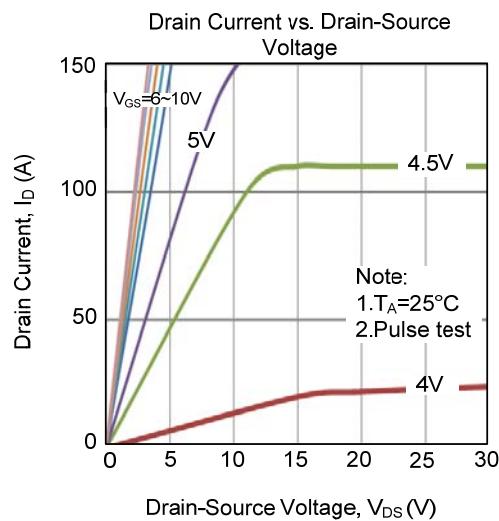
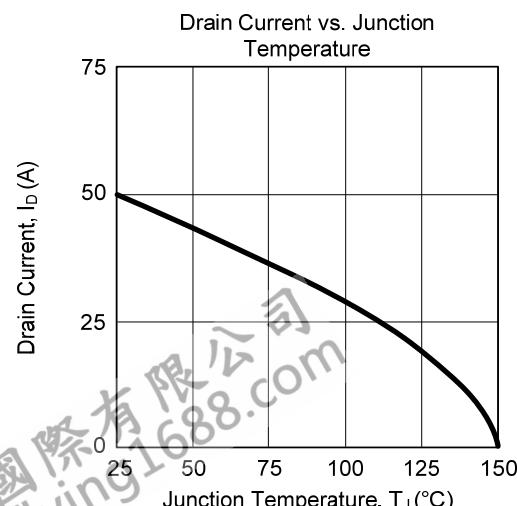
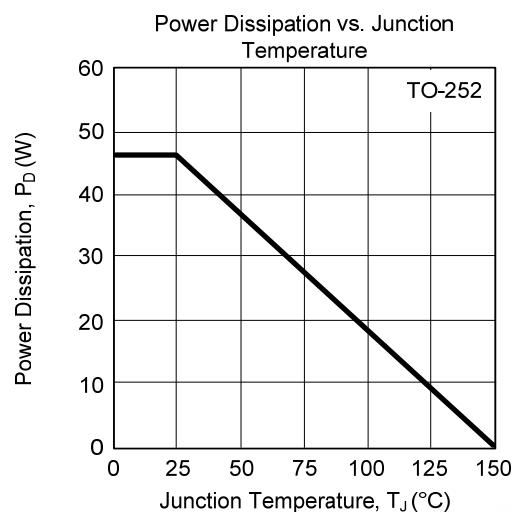
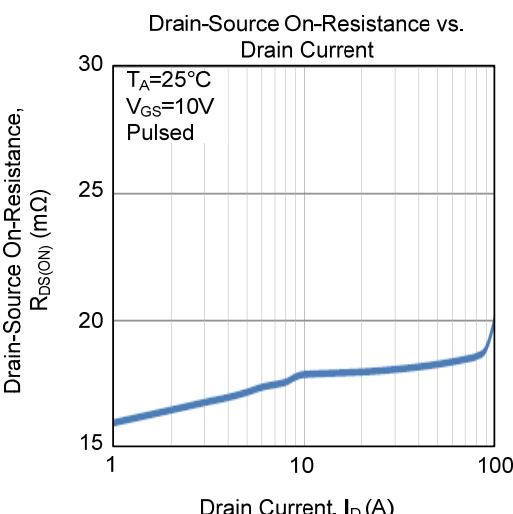
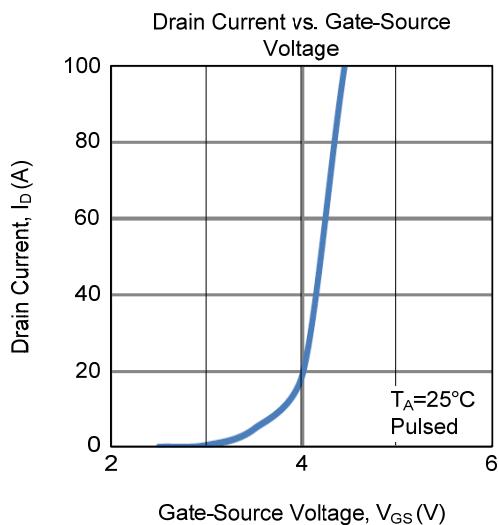
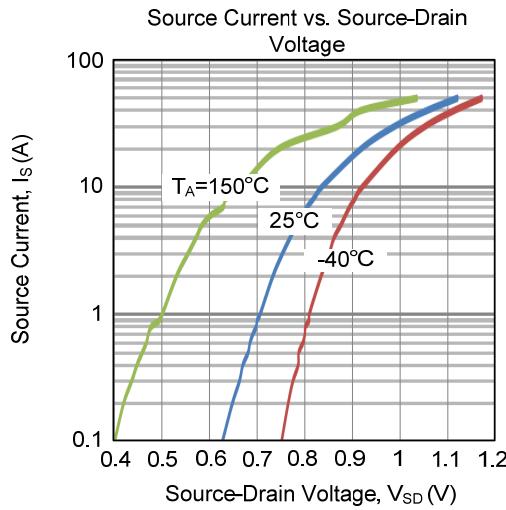
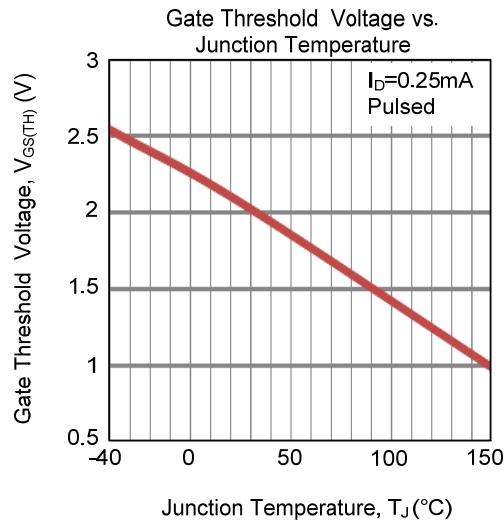


Fig. 4B Unclamped Inductive Switching Waveforms

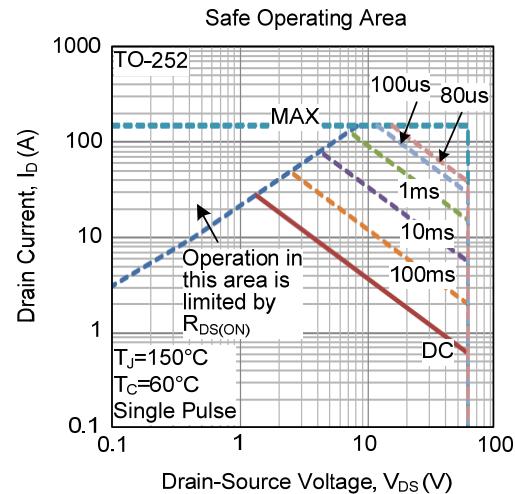
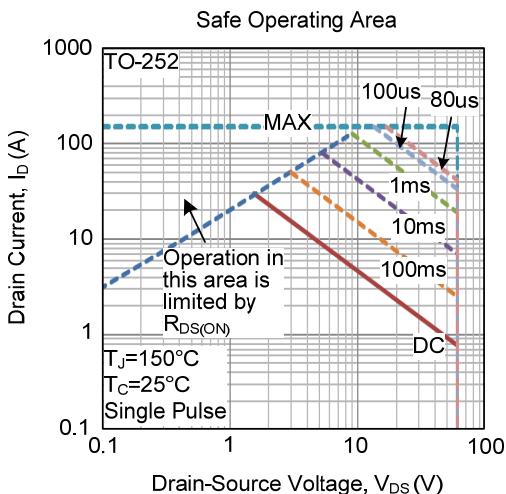
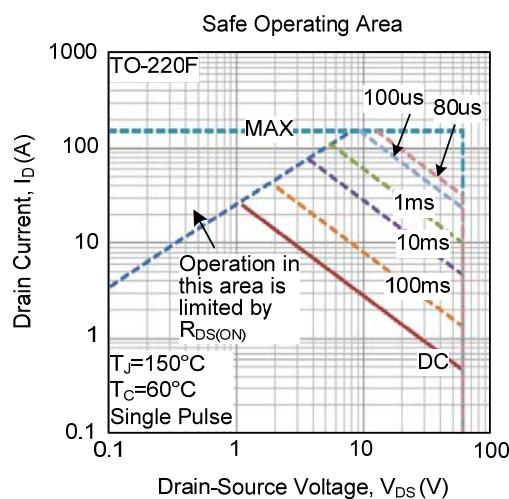
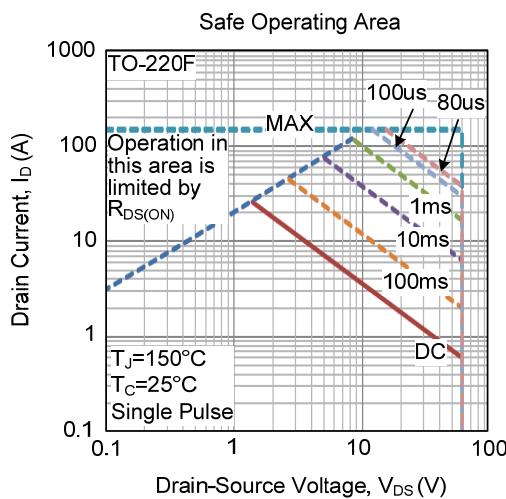
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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